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Applications of "<u>Embedded - Microcontrollers</u>"

etails	
oduct Status	Active
ore Processor	R8C
ore Size	16-Bit
peed	20MHz
onnectivity	LINbus, SIO, UART/USART
ripherals	POR, PWM, Voltage Detect, WDT
umber of I/O	25
ogram Memory Size	8KB (8K x 8)
ogram Memory Type	FLASH
PROM Size	-
M Size	512 x 8
tage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
ta Converters	A/D 12x10b; D/A 2x8b
cillator Type	Internal
erating Temperature	-40°C ~ 85°C (TA)
ounting Type	Surface Mount
ckage / Case	32-LQFP
ipplier Device Package	32-LQFP (7x7)
rchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f212f2dfp-w4

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# 1.1.2 Specifications

Tables 1.1 and 1.2 outlines the Specifications for R8C/2E Group and Tables 1.3 and 1.4 outlines the Specifications for R8C/2F Group.

Table 1.1 Specifications for R8C/2E Group (1)

Item	Function	Specification
CPU	Central	R8C/Tiny series core
	processing unit	Number of fundamental instructions: 89
		Minimum instruction execution time:
		50 ns (f(XIN) = 20 MHz, VCC = 3.0 to 5.5 V)
		100 ns (f(XIN) = 10 MHz, VCC = 2.7 to 5.5 V)
		Multiplier: 16 bits × 16 bits → 32 bits
		• Multiply-accumulate instruction: 16 bits × 16 bits + 32 bits → 32 bits
		Operation mode: Single-chip mode (address space: 1 Mbyte)
Memory	ROM, RAM	Refer to Table 1.5 Product List for R8C/2E Group.
Power Supply	Voltage	Power-on reset
Voltage	detection circuit	Voltage detection 2
Detection		Totage detection _
I/O Ports	Programmable	Input-only: 3 pins
,, 0 , 0, 10	I/O ports	CMOS I/O ports: 25, selectable pull-up resistor
	" o porto	• High current drive ports: 8
Clock	Clock generation	2 circuits: XIN clock oscillation circuit (with on-chip feedback resistor),
Olook	circuits	On-chip oscillator (high-speed, low-speed)
	Onouns	(high-speed on-chip oscillator has a frequency adjustment
		function)
		Oscillation stop detection: XIN clock oscillation stop detection
		function
		• Frequency divider circuit: Dividing selectable 1, 2, 4, 8, and 16
		• Low power consumption modes:
		Standard operating mode (high-speed clock, high-speed on-chip
Interrupte		oscillator, low-speed on-chip oscillator), wait mode, stop mode
Interrupts		• External: 4 sources, Internal: 13 sources, Software: 4 sources
Watchdog Tim	or	<ul> <li>Priority levels: 7 levels</li> <li>15 bits x 1 (with prescaler), reset start selectable</li> </ul>
Timer	Timer RA	8 bits × 1 (with 8-bit prescaler)
Tillel	Tilllel KA	Timer mode (period timer), pulse output mode (output level inverted
		every period), event counter mode, pulse width measurement mode,
		pulse period measurement mode
	Timer RB	8 bits × 1 (with 8-bit prescaler)
	Tilliel IXD	Timer mode (period timer), programmable waveform generation
		mode (PWM output), programmable one-shot generation mode,
		programmable wait one-shot generation mode
	Timer RC	16 bits × 1 (with 4 capture/compare registers)
	Timer ite	Timer mode (input capture function, output compare function), PWM
		mode (output 3 pins), PWM2 mode (PWM output pin)
	Timer RE	8 bits × 1
		Output compare mode
Serial	UART0	Clock synchronous serial I/O/UART x 1
Interface		
LIN Module	l	Hardware LIN: 1 (timer RA, UART0)
A/D Converter	•	10-bit resolution × 12 channels, includes sample and hold function
D/A Converter		8-bit resolution × 2 circuits
Comparator		2 circuits
		1

Table 1.2 Specifications for R8C/2E Group (2)

Item	Specification
Flash Memory	<ul> <li>Programming and erasure voltage: VCC = 2.7 to 5.5 V</li> </ul>
	Programming and erasure endurance: 100 times
	Program security: ROM code protect, ID code check
	Debug functions: On-chip debug, on-board flash rewrite function
Operating Frequency/Supply	f(XIN) = 20 MHz (VCC = 3.0 to 5.5 V),
Voltage	f(XIN) = 10  MHz (VCC = 2.7  to  5.5  V)
Current consumption	Typ. 10 mA (VCC = 5.0 V, f(XIN) = 20 MHz) Typ. 6 mA (VCC = 3.0 V, f(XIN) = 10 MHz)
	Typ. 23 $\mu$ A (VCC = 3.0 V, wait mode (peripheral clock off)) Typ. 0.7 $\mu$ A (VCC = 3.0 V, stop mode)
Operating Ambient Temperature	-20 to 85°C (N version)
Operating Ambient Temperature	-40 to 85°C (D version) <sup>(1)</sup>
Package	32-pin LQFP
	Package code: PLQP0032GB-A (previous code: 32P6U-A)

1. Specify the D version if D version functions are to be used.

#### 1.2 **Product List**

Table 1.5 lists Product List for R8C/2E Group, Figure 1.1 shows a Part Number, Memory Size, and Package of R8C/2E Group, Table 1.6 lists Product List for R8C/2F Group, and Figure 1.2 shows a Part Number, Memory Size, and Package of R8C/2F Group.

Table 1.5 **Product List for R8C/2E Group** 

Current of Dec. 2007

Part No.	ROM Capacity	RAM Capacity	Package Type	Remarks
R5F212E2NFP	8 Kbytes	512 bytes	PLQP0032GB-A	N version
R5F212E4NFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	
R5F212E2DFP	8 Kbytes	512 bytes	PLQP0032GB-A	D version
R5F212E4DFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	
R5F212E2NXXXFP	8 Kbytes	512 bytes	PLQP0032GB-A	N version
R5F212E4NXXXFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	Factory programming product <sup>(1)</sup>
R5F212E2DXXXFP	8 Kbytes	512 bytes	PLQP0032GB-A	D version
R5F212E4DXXXFP	16 Kbytes	1 Kbyte	PLQP0032GB-A	Factory programming product <sup>(1)</sup>

#### NOTE:

1. The user ROM is programmed before shipment.

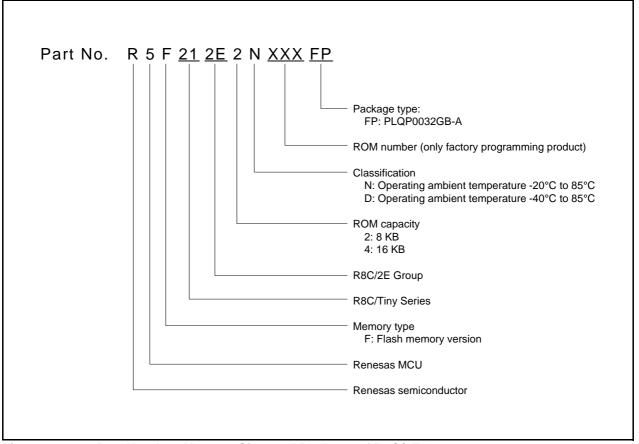


Figure 1.1 Part Number, Memory Size, and Package of R8C/2E Group

# 1.4 Pin Assignment

Figure 1.4 shows Pin Assignments (Top View). Table 1.7 outlines the Pin Name Information by Pin Number.

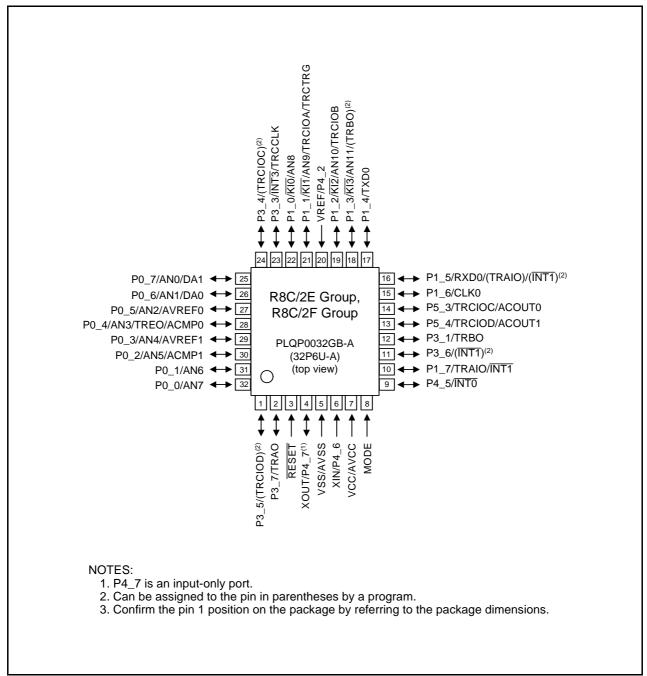


Figure 1.4 Pin Assignments (Top View)

Pin Name Information by Pin Number Table 1.7

Pin				I/O Pin F	unctions for	of Peripheral I	Modules	
Number	Control Pin	Port	Interrupt	Timer	Serial Interface	A/D Converter	D/A Converter	Comparator
1		P3_5		(TRCIOD)(1)				
2		P3_7		TRAO				
3	RESET							
4	XOUT	P4_7						
5	VSS/AVSS							
6	XIN	P4_6						
7	VCC/AVCC							
8	MODE							
9		P4_5	INT0					
10		P1_7	INT1	TRAIO				
11		P3_6	(INT1) <sup>(1)</sup>					
12		P3_1		TRBO				
13		P5_4		TRCIOD				ACOUT1
14		P5_3		TRCIOC				ACOUT0
15		P1_6			CLK0			
16		P1_5	(INT1) <sup>(1)</sup>	(TRAIO) <sup>(1)</sup>	RXD0			
17		P1_4			TXD0			
18		P1_3	KI3	(TRBO) <sup>(1)</sup>		AN11		
19		P1_2	KI2	TRCIOB		AN10		
20	VREF	P4_2						
21		P1_1	KI1	TRCIOA/ TRCTRG		AN9		
22		P1_0	KI0			AN8		
23		P3_3	ĪNT3	TRCCLK				
24		P3_4		(TRCIOC) <sup>(1)</sup>				
25		P0_7				AN0	DA1	
26		P0_6				AN1	DA0	
27		P0_5				AN2		AVREF0
28		P0_4		TREO		AN3		ACMP0
29		P0_3				AN4		AVREF1
30		P0_2				AN5		ACMP1
31		P0_1				AN6		
32		P0_0				AN7		

1. Can be assigned to the pin in parentheses by a program.

# 3. Memory

# 3.1 R8C/2E Group

Figure 3.1 is a Memory Map of R8C/2E Group. The R8C/2E group has 1 Mbyte of address space from addresses 00000h to FFFFFh.

The internal ROM is allocated lower addresses, beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM area is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal RAM is allocated higher addresses beginning with address 00400h. For example, a 1-Kbyte internal RAM area is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.

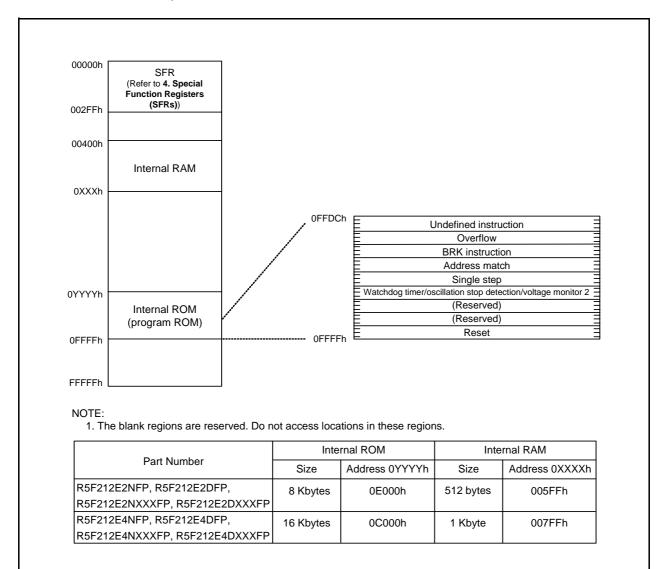


Figure 3.1 Memory Map of R8C/2E Group

## 3.2 R8C/2F Group

Figure 3.2 is a Memory Map of R8C/2F Group. The R8C/2F group has 1 Mbyte of address space from addresses 00000h to FFFFFh.

The internal ROM (program ROM) is allocated lower addresses, beginning with address 0FFFFh. For example, a 16-Kbyte internal ROM area is allocated addresses 0C000h to 0FFFFh.

The fixed interrupt vector table is allocated addresses 0FFDCh to 0FFFFh. They store the starting address of each interrupt routine.

The internal ROM (data flash) is allocated addresses 02400h to 02BFFh.

The internal RAM area is allocated higher addresses, beginning with address 00400h. For example, a 1-Kbyte internal RAM is allocated addresses 00400h to 007FFh. The internal RAM is used not only for storing data but also for calling subroutines and as stacks when interrupt requests are acknowledged.

Special function registers (SFRs) are allocated addresses 00000h to 002FFh. The peripheral function control registers are allocated here. All addresses within the SFR, which have nothing allocated are reserved for future use and cannot be accessed by users.

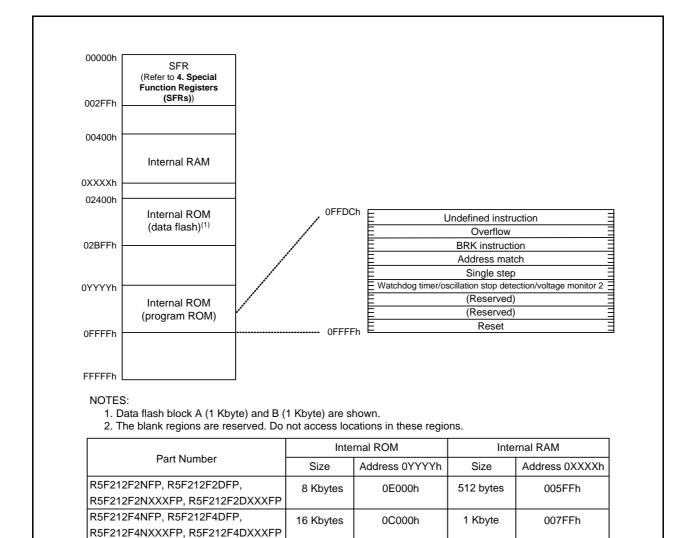


Figure 3.2 Memory Map of R8C/2F Group

SFR Information (3)<sup>(1)</sup> Table 4.3

Address	Register	Symbol	After reset
0080h	r togistor	Cymbol	71101 10001
0081h			
0082h			
0083h			
0084h			
0085h			
0086h			
0087h			
0088h			
0089h			
008Ah			
008Bh			
008Ch			
008Dh			
008Eh			
008Fh			
0090h			
0090H			
009111 0092h			
0092h 0093h			
0093h 0094h			
0095h 0096h			
0096h 0097h			
0098h			
0099h			
009Ah			
009Bh			
009Ch			
009Dh			
009Eh			
009Fh			
00A0h	UART0 Transmit/Receive Mode Register	U0MR	00h
00A1h	UARTO Bit Rate Register	U0BRG	XXh
00A1h 00A2h	UARTO Bit Rate Register UARTO Transmit Buffer Register		XXh XXh
00A1h 00A2h 00A3h	UART0 Bit Rate Register UART0 Transmit Buffer Register	U0BRG U0TB	XXh XXh XXh
00A1h 00A2h 00A3h 00A4h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0	U0BRG U0TB U0C0	XXh XXh XXh 00001000b
00A1h 00A2h 00A3h 00A4h 00A5h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 0000010b
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0	U0BRG U0TB U0C0	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 0000010b
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
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00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh 00AFh 00AFh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh 00AFh 00AFh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ADh 00AEh 00AFh 00B0h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00AEh 00AEh 00AEh 00AEh 00AEh 00AEh 00AEh 00B0h 00B1h 00B2h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00ACh 00B1h 00B1h 00B2h 00B3h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00B0h 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00B1h 00B2h 00B3h 00B4h 00B5h 00B5h 00B7h 00B8h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00B0h 00B1h 00B2h 00B3h 00B5h 00B6h 00B5h 00B6h 00B7h 00B8h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00B1h 00B2h 00B3h 00B5h 00B6h 00B7h 00B8h 00B8h 00B9h	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00BAh 00BAh 00BB	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00B9h 00BAh 00BCh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh
00A1h 00A2h 00A2h 00A3h 00A4h 00A5h 00A6h 00A7h 00A8h 00A9h 00AAh 00ABh 00ACh 00ACh 00AFh 00B1h 00B2h 00B3h 00B4h 00B5h 00B6h 00B7h 00B8h 00BAh 00BAh 00BAh	UART0 Bit Rate Register UART0 Transmit Buffer Register  UART0 Transmit/Receive Control Register 0  UART0 Transmit/Receive Control Register 1	U0BRG U0TB U0C0 U0C1	XXh XXh XXh 00001000b 00000010b XXh

X: Undefined
NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (6)<sup>(1)</sup> Table 4.6

Address	Register	Symbol	After reset
0140h	•		
0141h			
0142h			
0143h			
0144h			
0145h			
0146h			
0147h			
0148h			
0149h			
014Ah			
014Bh			
014Ch			
014Dh			
014Eh			
014Fh			
0150h			
0151h			
0152h			
0153h			
0154h 0155h			
0156h			
0157h			
0157H			
0159h			
015Ah			
015Bh			
015Ch			
015Dh			
015Eh			
015Fh			
0160h			
0161h			
0162h			
0163h			
0164h			
0165h			
0166h			
0167h			
0168h			
0169h			
016Ah			
016Bh			
016Ch			
016Dh			
016Eh			
016Fh			
0170h			
0171h			
0172h			
0173h 0174h	Comparator 0 Control Register	ACCR0	00001000b
0174h 0175h	Comparator 1 Control Register  Comparator 1 Control Register	ACCR0 ACCR1	00001000b
0175h	Comparator / Control negister	AUUN I	000010000
0176H	Comparator Mode Register	ACMR	00h
0177h	Comparator mode register	, COIVII C	00.1
0178h			
0179H 017Ah			
017An			
017Ch			
017Dh			
017Eh			
017Fh			
X: Undefined			

X: Undefined
NOTE:

1. The blank regions are reserved. Do not access locations in these regions.

SFR Information (7)<sup>(1)</sup> Table 4.7

Address	Register	Symbol	After reset
0180h		5,	7.11.01.10001
0181h			
0182h			
0183h			
0184h			
0185h			
0186h			
0187h			
0188h			
0189h			
018Ah			
018Bh			
018Ch			
018Dh			
018Eh			
018Fh			
0190h			
0191h			
0191h 0192h			
0192h			
0193h 0194h			
0194h 0195h			
01950			
0196h			
0197h			
0198h 0199h			
019Ah			
019Bh			
019Ch			
019Dh			
019Eh			
019Fh			
01A0h			
01A1h			
01A2h			
01A3h			
01A4h			
01A5h			
01A6h			
01A7h			
01A8h			
01A9h			
01AAh			
01ABh			
01ACh			
01ADh			
01AEh			
01AFh			
01B0h			
01B1h			
01B2h	Florit Manager Constrail Descriptor 4	EMD4	04000000
01B3h	Flash Memory Control Register 4	FMR4	01000000b
01B4h	Florit Manager Constrail Descriptors	EMD4	4000000Vb
01B5h	Flash Memory Control Register1	FMR1	1000000Xb
01B6h	EL LM	EMPO	0000004
01B7h	Flash Memory Control Register 0	FMR0	00000001b
01B8h			
01B9h			
01BAh			
01BBh			
01BCh			
01BDh			
01BEh			
01BFh			
-			

FFFFh Option Function Select Register OFS (Note 2)

X: Undefined

- The blank regions are reserved. Do not access locations in these regions.
   The OFS register cannot be changed by a program. Use a flash programmer to write to it.

#### **Electrical Characteristics** 5.

**Absolute Maximum Ratings** Table 5.1

Symbol	Parameter	Condition	Rated Value	Unit
Vcc/AVcc	Supply voltage		-0.3 to 6.5	V
Vı	Input voltage		-0.3 to Vcc + 0.3	V
Vo	Output voltage		-0.3 to Vcc + 0.3	V
Pd	Power dissipation	Topr = 25°C	500	mW
Topr	Operating ambient temperature		-20 to 85 (N version) / -40 to 85 (D version)	°C
Tstg	Storage temperature		-65 to 150	°C

Table 5.2 **Recommended Operating Conditions** 

0	Danamatan	Conditions		Standard			
Symbol		Parameter	Conditions	Min.	Тур.	Max.	Unit
Vcc/AVcc	Supply voltage			2.7	_	5.5	V
Vss/AVss	Supply voltage			-	0	_	V
VIH	Input "H" voltage			0.8 Vcc	-	Vcc	V
VIL	Input "L" voltage			0	-	0.2 Vcc	V
IOH(sum)	Peak sum output "H" current	Sum of all pins IOH(peak)		-	_	-160	mA
IOH(sum)	Average sum output "H" current	Sum of all pins IOH(avg)		-	=	-80	mA
IOH(peak)	Peak output "H"	Except P1_0 to P1_7		-	-	-10	mA
	current	P1_0 to P1_7		-	_	-20	mA
IOH(avg)	Average output	Except P1_0 to P1_7		-	_	-5	mA
	"H" current	P1_0 to P1_7		_	_	-10	mA
IOL(sum)	Peak sum output "L" currents	Sum of all pins IOL(peak)		-	=	160	mA
IOL(sum)	Average sum output "L" currents	Sum of all pins IOL(avg)		-	=	80	mA
IOL(peak)	Peak output "L"	Except P1_0 to P1_7		-	_	10	mA
	currents	P1_0 to P1_7		-	-	20	mA
IOL(avg)	Average output	Except P1_0 to P1_7		-	=	5	mA
	"L" current	P1_0 to P1_7		-	=	10	mA
f(XIN)	XIN clock input osc	illation frequency	3.0 V ≤ Vcc ≤ 5.5 V	0	=	20	MHz
			2.7 V ≤ Vcc < 3.0 V	0	=	10	MHz
=	System clock	OCD2 = 0	3.0 V ≤ Vcc ≤ 5.5 V	0	=	20	MHz
		XIN clock selected	2.7 V ≤ Vcc < 3.0 V	0	=	10	MHz
		OCD2 = 1 On-chip oscillator clock selected	FRA01 = 0 Low-speed on-chip oscillator clock selected	_	125	-	kHz
			FRA01 = 1 High-speed on-chip oscillator clock selected 3.0 V ≤ Vcc ≤ 5.5 V	_	-	20	MHz
			FRA01 = 1 High-speed on-chip oscillator clock selected 2.7 V ≤ Vcc ≤ 5.5 V	_	_	10	MHz

- Vcc = 2.7 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
   The average output current indicates the average value of current measured during 100 ms.

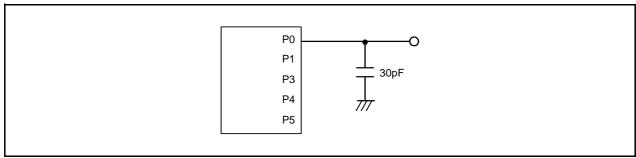


Figure 5.1 Ports P0, P1, and P3 to P5 Timing Measurement Circuit

Table 5.3 A/D Converter Characteristics

Symbol	Parameter	Conditions	Standard			Unit	
Symbol	'	arameter Conditions		Min.	Тур.	Max.	Unit
_	Resolution		Vref = AVCC	=	-	10	Bits
_	Absolute	10-bit mode	φAD = 10 MHz, Vref = AVCC = 5.0 V	=	-	±3	LSB
	accuracy	8-bit mode	φAD = 10 MHz, Vref = AVCC = 5.0 V	=	-	±2	LSB
		10-bit mode	φAD = 10 MHz, Vref = AVCC = 3.3 V	=	-	±5	LSB
		8-bit mode	φAD = 10 MHz, Vref = AVCC = 3.3 V	-	-	±2	LSB
Rladder	Resistor ladder		Vref = AVCC	10	-	40	kΩ
tconv	Conversion time	10-bit mode	φAD = 10 MHz, Vref = AVCC = 5.0 V	3.3	-	_	μS
		8-bit mode	φAD = 10 MHz, Vref = AVCC = 5.0 V	2.8	-	_	μS
Vref	Reference voltag	e		2.7	-	AVcc	V
VIA	Analog input voltage(2)			0	-	AVcc	V
-	A/D operating	Without sample and hold	Vref = AVCC = 2.7 to 5.5 V	0.25	-	10	MHz
	clock frequency	With sample and hold	Vref = AVCC = 2.7 to 5.5 V	1	-	10	MHz

- 1. AVcc = 2.7 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- 2. When the analog input voltage is over the reference voltage, the A/D conversion result will be 3FFh in 10-bit mode and FFh in 8-bit mode.

Table 5.4 D/A Converter Characteristics

Symbol	Parameter	Conditions	Standard			Unit
Symbol	Farameter	Conditions	Min.	Тур.	Max.	Offic
-	Resolution		-	-	8	Bit
-	Absolute accuracy		_	-	1.0	%
tsu	Setup time		_	-	3	μS
Ro	Output resistor		4	10	20	kΩ
lVref	Reference power input current	(NOTE 2)	-	=	1.5	mA

- 1. AVcc = 2.7 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- 2. This applies when one D/A converter is used and the value of the DAi register (i = 0 or 1) for the unused D/A converter is 00h. The resistor ladder of the A/D converter is not included. Also, even if the VCUT bit in the ADCON1 register is set to 0 (VREF not connected), Ivref flows into the D/A converters.



Table 5.7 Flash Memory (Data flash Block A, Block B) Electrical Characteristics(4)

Symbol	Parameter	Conditions		Stand	ard	Unit
Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
_	Program/erase endurance <sup>(2)</sup>		10,000(3)	-	-	times
_	Byte program time (program/erase endurance ≤ 1,000 times)		_	50	400	μS
_	Byte program time (program/erase endurance > 1,000 times)		_	65	_	μS
_	Block erase time (program/erase endurance ≤ 1,000 times)		_	0.2	9	S
_	Block erase time (program/erase endurance > 1,000 times)		_	0.3	-	S
td(SR-SUS)	Time delay from suspend request until suspend		=	-	97+CPU clock × 6 cycles	μS
_	Interval from erase start/restart until following suspend request		650	-	_	μS
_	Interval from program start/restart until following suspend request		0	-	-	ns
_	Time from suspend until program/erase restart		_	-	3+CPU clock × 4 cycles	μS
-	Program, erase voltage		2.7	_	5.5	V
_	Read voltage		2.7	_	5.5	V
=	Program, erase temperature		-20 <sup>(8)</sup>	-	85	°C
_	Data hold time <sup>(9)</sup>	Ambient temperature = 55 °C	20	_	-	year

- 1. Vcc = 2.7 to 5.5 V at Topr = -20 to 85°C (N version) / -40 to 85°C (D version), unless otherwise specified.
- 2. Definition of programming/erasure endurance
  - The programming and erasure endurance is defined on a per-block basis.

If the programming and erasure endurance is n (n = 100 or 10,000), each block can be erased n times. For example, if 1,024 1-byte writes are performed to block A, a 1 Kbyte block, and then the block is erased, the programming/erasure endurance still stands at one.

However, the same address must not be programmed more than once per erase operation (overwriting prohibited).

- 3. Endurance to guarantee all electrical characteristics after program and erase. (1 to Min. value can be guaranteed).
- 4. Standard of block A and block B when program and erase endurance exceeds 1,000 times. Byte program time to 1,000 times is the same as that in program ROM.
- 5. In a system that executes multiple programming operations, the actual erasure count can be reduced by writing to sequential addresses in turn so that as much of the block as possible is used up before performing an erase operation. For example, when programming groups of 16 bytes, the effective number of rewrites can be minimized by programming up to 128 groups before erasing them all in one operation. It is also advisable to retain data on the erase count of each block and limit the number of erase operations to a certain number.
- 6. If an error occurs during block erase, attempt to execute the clear status register command, then execute the block erase command at least three times until the erase error does not occur.
- 7. Customers desiring program/erase failure rate information should contact their Renesas technical support representative.
- 8. –40°C for D version.
- 9. The data hold time includes time that the power supply is off or the clock is not supplied.

**Table 5.11 High-speed On-Chip Oscillator Circuit Electrical Characteristics** 

Symbol	Parameter	Condition		Standard		Unit
Syllibol	Farameter	Condition	Min.	Тур.	Max.	Offic
fOCO40M	High-speed on-chip oscillator frequency temperature • supply voltage dependence	Vcc = 4.75 V to 5.25 V $0^{\circ}$ C $\leq$ Topr $\leq$ 60°C(2)	39.2	40	40.8	MHz
		Vcc = 3.0  V to  5.5  V $-20^{\circ}\text{C} \le \text{Topr} \le 85^{\circ}\text{C}^{(2)}$	38.8	40	41.2	MHz
		Vcc = 3.0  V to  5.5  V $-40^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}^{(2)}$	38.4	40	41.6	MHz
Higl		Vcc = 2.7  V to  5.5  V -20°C \le Topr \le 85°C <sup>(2)</sup>	38	40	42	MHz
		Vcc = 2.7  V to  5.5  V -40°C \le Topr \le 85°C(2)	37.6	40	42.4	MHz
		$Vcc = 5.0 \text{ V } \pm 10\%$ $-20^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}^{(2)}$	38.8	40	40.8	MHz
		$Vcc = 5.0 \text{ V } \pm 10\%$ $-40^{\circ}\text{C} \leq \text{Topr} \leq 85^{\circ}\text{C}^{(2)}$	38.4	40	40.8	MHz
	High-speed on-chip oscillator frequency when	Vcc = 5.0 V, Topr = 25°C	_	36.864	_	MHz
	correction value in FRA7 register is written to FRA1 register	Vcc = 2.7 V to 5.5 V -20°C ≤ Topr ≤ 85°C	-3%	-	3%	%
_	Value in FRA1 register after reset		08h	-	F7h	_
_	Oscillation frequency adjustment unit of high- speed on-chip oscillator	Adjust FRA1 register (value after reset) to -1	-	+0.3	-	MHz
=	Oscillation stability time		-	10	100	μS
=	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	=	400	_	μΑ

- 1. Vcc = 2.7 to 5.5 V,  $T_{opr} = -20 \text{ to } 85^{\circ}\text{C}$  (N version) /  $-40 \text{ to } 85^{\circ}\text{C}$  (D version), unless otherwise specified.
- 2. These standard values show when the FRA1 register value after reset is assumed.

**Table 5.12 Low-speed On-Chip Oscillator Circuit Electrical Characteristics** 

Symbol	Parameter	Condition		Standard		Unit
Symbol	Falametei	Condition	Min.	Тур.	Max.	Offic
fOCO-S	Low-speed on-chip oscillator frequency		30	125	250	kHz
=	Oscillation stability time		=	10	100	μS
_	Self power consumption at oscillation	Vcc = 5.0 V, Topr = 25°C	=	15	=	μΑ

### NOTE:

1. Vcc = 2.7 to 5.5 V,  $T_{opr} = -20$  to  $85^{\circ}C$  (N version) / -40 to  $85^{\circ}C$  (D version), unless otherwise specified.

**Table 5.13 Power Supply Circuit Timing Characteristics** 

Svmbol	Parameter	Condition	,	Standard	d l	Unit
Syllibol	r alametel	Condition	Min.	Тур.	Max.	Offic
td(P-R)	Time for internal power supply stabilization during power-on <sup>(2)</sup>		1	=	2000	μS
td(R-S)	STOP exit time <sup>(3)</sup>		-	-	150	μS

- 1. The measurement condition is Vcc = 2.7 to 5.5 V and Topr = 25°C.
- 2. Waiting time until the internal power supply generation circuit stabilizes during power-on.
- 3. Time until system clock supply starts after the interrupt is acknowledged to exit stop mode.



# **Timing Requirements**

(Unless Otherwise Specified: Vcc = 5 V, Vss = 0 V at Topr = 25°C) [Vcc = 5 V]

Table 5.16 XIN Input

Symbol	Parameter	Stan	dard	Unit
Symbol	Symbol Parameter		Max.	Offic
tc(XIN)	XIN input cycle time	50	-	ns
twh(xin)	XIN input "H" width	25	-	ns
twl(XIN)	XIN input "L" width	25	-	ns

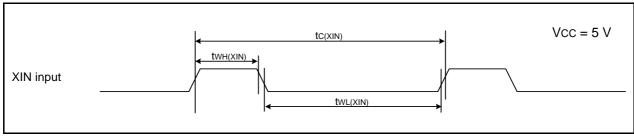


Figure 5.4 XIN Input Timing Diagram when Vcc = 5 V

Table 5.17 TRAIO Input

Symbol	Parameter	Stan	dard	Unit
Symbol	raidilletei	Min.	Max.	Offic
tc(TRAIO)	TRAIO input cycle time	100	=	ns
twh(traio)	TRAIO input "H" width	40	=	ns
tWL(TRAIO)	TRAIO input "L" width	40	-	ns

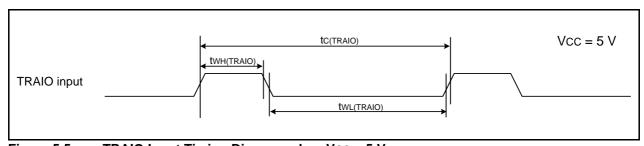


Figure 5.5 TRAIO Input Timing Diagram when Vcc = 5 V

Table 5.18 Serial Interface	Serial Inter	face
-----------------------------	--------------	------

Symbol	Parameter	Stan	dard	Unit
Symbol	Farameter	Min.	Max.	Unit
tc(CK)	CLK0 input cycle time	200	-	ns
tW(CKH)	CLK0 input "H" width	100	-	ns
tW(CKL)	CLK0 input "L" width	100	-	ns
td(C-Q)	TXD0 output delay time	-	50	ns
th(C-Q)	TXD0 hold time	0	-	ns
tsu(D-C)	RXD0 input setup time	50	=	ns
th(C-D)	RXD0 input hold time	90	-	ns

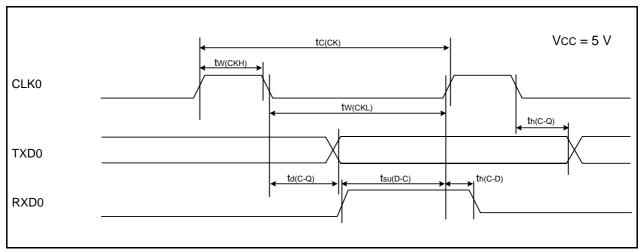


Figure 5.6 Serial Interface Timing Diagram when Vcc = 5 V

Table 5.19 External Interrupt INTi (i = 0, 1, 3) Input

Symbol	Parameter	Stan	Standard	
Symbol	Falanielei	Min.	Max.	Unit
tW(INH)	ĪNTi input "H" width	250 <sup>(1)</sup>	-	ns
tw(INL)	INTi input "L" width	250(2)	-	ns

- 1. When selecting the digital filter by the INTi input filter select bit, use an INTi input HIGH width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.
- 2. When selecting the digital filter by the INTi input filter select bit, use an INTi input LOW width of either (1/digital filter clock frequency × 3) or the minimum value of standard, whichever is greater.

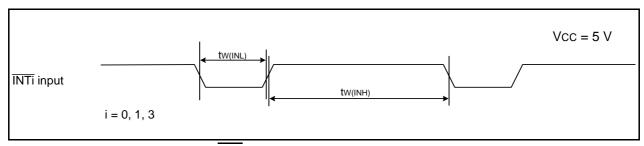


Figure 5.7 External Interrupt INTi Input Timing Diagram when Vcc = 5 V

# **Timing requirements**

(Unless Otherwise Specified: Vcc = 3 V, Vss = 0 V at Topr = 25°C) [Vcc = 3 V]

Table 5.22 XIN Input

Symbol	Parameter	Stan	dard	Unit
Symbol	Falameter	Min.	Max.	Offic
tc(XIN)	XIN input cycle time	100	-	ns
twh(xin)	XIN input "H" width	40	-	ns
twl(XIN)	XIN input "L" width	40	-	ns

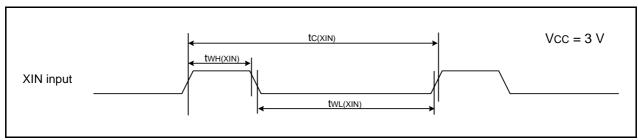


Figure 5.8 XIN Input Timing Diagram when Vcc = 3 V

Table 5.23 TRAIO Input

Symbol	Parameter	Stan	dard	Unit
Symbol	raidilletei	Min.	Max.	Offic
tc(TRAIO)	TRAIO input cycle time	300	=	ns
tWH(TRAIO)	TRAIO input "H" width	120	=	ns
tWL(TRAIO)	TRAIO input "L" width	120	-	ns

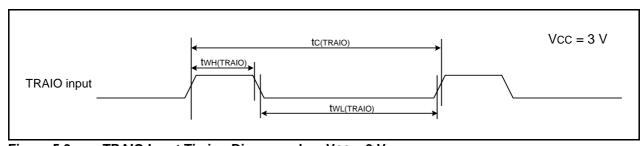


Figure 5.9 TRAIO Input Timing Diagram when Vcc = 3 V

REVISION HISTORY	R8C/2E Group, R8C/2F Group Datasheet
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Rev.	Date	Description			
		Page	Summary		
0.10	Aug 01, 2007	_	First Edition issued		
1.00	Dec 14, 2007	All pages	"Under development" deleted		
		2, 4	Table 1.1, Table 1.3: "Interrupts" revised		
		6, 7	Table 1.5, Table 1.6: "(D)" deleted		
		15, 16	Figure 3.1, Figure 3.2: "Expanded area" deleted		
		17	Table 4.1: "002Ch" added		
		24	Table 5.2: IOH(sum), NOTE2 revised		
		30	Table 5.11: Symbol "fOCO40M"; Parameter added		

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